

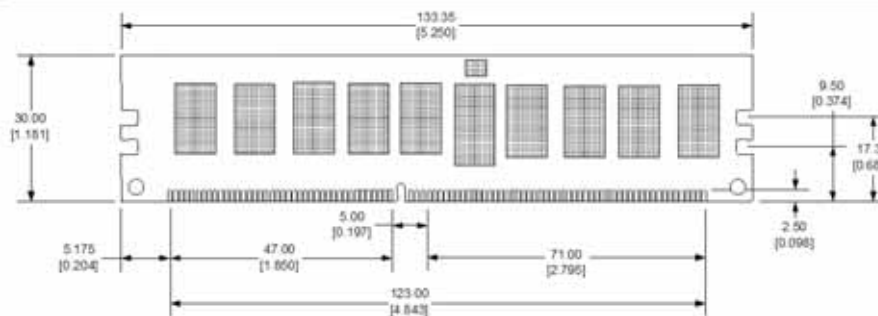
Products in Family

GRSX6270-10/2GB (1 x 2GB 1Rx4 DIMMs)
 GRSX6270-810/2GB (1 x 2GB 2Rx8 DIMMs)
 GRSX6270-10/4GB (1 x 4GB 2Rx4 DIMMs)
 GRSX6270-10/8GB (1 x 8GB 2Rx4 DIMMs)



| Features | | Description |
|---|--|--|
| 240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V ±0.075 Fully RoHS Compliant Thermal Sensor | | Each GRSX6270-10 upgrade consists of a single DDR3-1066 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-8500 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C. |
| Dataram Product | Sun Microsystems Product | Supported in these Sun Microsystems systems: |
| GRSX6270-10/2GB GRSX6270-810/2GB GRSX6270-10/4GB GRSX6270-10/8GB | X4650A Not Offered by Sun X4651A X4652A | Sun Blade X6270 Server Module |

Front view

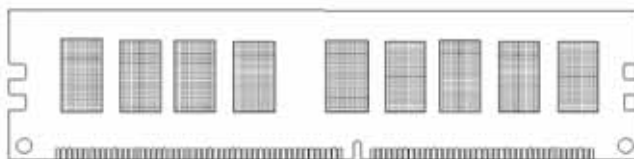


Notes

Tolerances on all dimensions except where otherwise indicated are \pm .13 (.005).

All dimensions are expressed in millimeters [inches]

Back view



Side view

